

XC7Z035-2FBG676I

XC7Z035-2FBG676I Information

	Embedded - System On Chip (SoC)tionIC SOC CORTEX-A9 KINTEX7 676BGA	
For Reference Only	Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



XC7Z035-2FBG676I Specifications

Manufacturer Part Number	XC7Z035-2FBG676I
Manufacturer	Xilinx Inc.
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Package	676-BBGA, FCBGA
Series	Zynq?-7000
Architecture	MCU, FPGA
Core Processor	Dual ARM? Cortex?-A9 MPCore? with CoreSight?
Flash Size	-
RAM Size	256KB
Peripherals	DMA
Connectivity	CAN, EBI/EMI, Ethernet, I2C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	800MHz
Primary Attributes	Kintex?-7 FPGA, 275K Logic Cells
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	676-BBGA, FCBGA
Supplier Device Package	676-FCBGA (27x27)
	Report errors?

XC7Z035-2FBG676I Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE UARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

XC7Z035-2FBG676I Payment Methods





If you have any question about XC7Z035-2FBG676I, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com